

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIROKAZU KOMORI	04/27/2016
HIROKI HIRAI	04/27/2016
TOMOYUKI SAKATA	04/27/2016
MAKOTO HIGASHIKOZONO	04/27/2016
MASATO TSUTSUKI	04/27/2016

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15317290

CORRESPONDENCE DATA

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NAME OF SUBMITTER: DANIEL B. MOON

SIGNATURE: /Daniel B. Moon/

DATE SIGNED: 12/08/2016

This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 7

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COMBINED INVENTOR'S DECLARATION AND ASSIGNMENT**DECLARATION**

The herein-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Authorization to Permit Access to Application by Participating Office

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the herein-identified patent application is filed access to the herein-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the herein-identified patent application is filed to have access to the herein-identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the herein-identified patent application with respect to: 1) the herein-identified patent application-as-filed; 2) any foreign application to which the herein-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the herein-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the herein-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

The undersigned hereby authorizes the U.S. attorney or agent appointed herein to accept and follow instructions from either his foreign patent agent or corporate representative, if any, as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned.

Direct Correspondence to: **CUSTOMER NUMBER 07055**

At: Greenblum & Bernstein, P.L.C.
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ASSIGNMENT

WHEREAS, **Hirokazu KOMORI**, a resident of Yokkaichi-shi, Mie, Japan, whose mailing address is c/o AUTONETWORKS TECHNOLOGIES, LTD., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 510-8503 JAPAN, **Hiroki HIRAI**, a resident of Yokkaichi-shi, Mie, Japan, whose mailing address is c/o AUTONETWORKS TECHNOLOGIES, LTD., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 510-8503 JAPAN, **Tomoyuki SAKATA**, a resident of Yokkaichi-shi, Mie, Japan, whose mailing address is c/o AUTONETWORKS TECHNOLOGIES, LTD., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 510-8503 JAPAN, **Makoto HIGASHIKOZONO**, a resident of Yokkaichi-shi, Mie, Japan, whose mailing address is c/o AUTONETWORKS TECHNOLOGIES, LTD., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 510-8503 JAPAN and **Masato TSUTSUKI**, a resident of Yokkaichi-shi, Mie, Japan, whose mailing address is c/o AUTONETWORKS TECHNOLOGIES, LTD., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 510-8503 JAPAN, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

SEALING STRUCTURE OF MULTICORE CABLE

for which they have executed, on the same date as this assignment, an application for Letters Patent for the United States to be filed in the United States Patent and Trademark Office, which Application is a National Stage of International Application No. _____, filed _____.

AND WHEREAS, **AUTONETWORKS TECHNOLOGIES, LTD.**, a corporation organized and existing under the laws of Yokkaichi-shi, Mie, Japan, whose mailing address is 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 510-8503 JAPAN, **SUMITOMO WIRING SYSTEMS, LTD.**, a corporation organized and existing under the laws of Yokkaichi-shi, Mie, Japan, whose mailing address is 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 510-8503 JAPAN, and **SUMITOMO ELECTRIC INDUSTRIES, LTD.**, a corporation organized and existing under the laws of Osaka-shi, Osaka, Japan, whose mailing address is 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 541-0041 JAPAN, hereinafter known as the ASSIGNEES, are desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEES, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEES and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during

the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said ASSIGNEES and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEES, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEES, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the respective dates indicated below.

First Witness (Optional):

(Name)

(Date)

Hirokazu Komori
Hirokazu KOMORI

April 27, 2016
Date

Second Witness (Optional):

(Name)

(Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness (Optional):

(Name)

(Date)

Hiroki Hirai

Hiroki HIRAI

April 27, 2016

Date

Second Witness (Optional):

(Name)

(Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness (Optional):

(Name)

(Date)

Tomoyuki Sakata
Tomoyuki SAKATA

April 27. 2016
Date

Second Witness (Optional):

(Name)

(Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness (Optional):

(Name)

(Date)

Makoto Higashikozone
Makoto HIGASHIKOZONO
April 27 2011
Date

Second Witness (Optional):

(Name)

(Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness (Optional):

(Name)

(Date)

Masato Tsutsuki
Masato TSUTSUKI

April 27, 2016
Date

Second Witness (Optional):

(Name)

(Date)